

FJP13007

NPN Silicon Transistor

High Voltage Switch Mode Application

- High Speed Switching
- Suitable for Electronic Ballast and Switching Regulator



1.Base 2.Collector 3.Emitter

Absolute Maximum Ratings T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CBO}	Collector-Base Voltage	700	V
V _{CEO}	Collector-Emitter Voltage	400	V
V _{EBO}	Emitter-Base Voltage	9	V
I _C	Collector Current (DC)	8	Α
I _{CP}	Collector Current (Pulse)	16	Α
I _B	Base Current	4	Α
P _C	Collector Dissipation (T _a = 25°C)	80	W
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	-65 ~ 150	°C

Electrical Characteristics $T_C = 25$ °C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max	Units
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C = 10mA, I _B = 0	400			V
I _{EBO}	Emitter Cut-off Current	$V_{EB} = 9V, I_{C} = 0$			1	mA
h _{FE1} h _{FE2}	DC Current Gain *	$V_{CE} = 5V, I_{C} = 2A$ $V_{CE} = 5V, I_{C} = 5A$	8 5		60 30	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = 2A, I_B = 0.4A$ $I_C = 5A, I_B = 1A$ $I_C = 8A, I_B = 2A$			1 2 3	V V V
V _{BE(sat)}	Base-Emitter Saturation Voltage	$I_C = 2A, I_B = 0.4A$ $I_C = 5A, I_B = 1A$			1.2 1.6	V V
f _T	Current Gain Bandwidth Product	V _{CE} = 10V, I _C = 0.5A	4			MHz
C _{ob}	Output Capacitance	V _{CB} = 10V, f = 0.1MHz		110		pF
t _{ON}	Turn On Time	$V_{CC} = 125V, I_{C} = 5A$			1.6	μs
t _{STG}	Storge Time	$I_{B1} = -I_{B2} = 1A$ $R_1 = 50\Omega$			3.0	μs
t _F	Fall Time	11/2 - 5032			0.7	μs

^{*} Pulse Test: PW $\leq 300 \mu s, \ Duty \ Cycle \leq 2\%$

\mathbf{h}_{FE} Classification

Classification	H1	H2	
h _{FE1}	15 ~ 28	26 ~ 39	

Typical Performance Characteristics

Figure 1. DC Current Gain

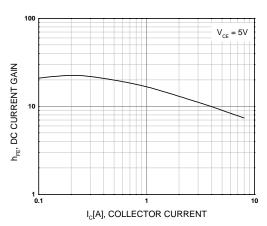


Figure 2. Saturation Voltage

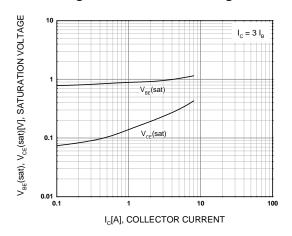


Figure 3. Collector Output Capacitance

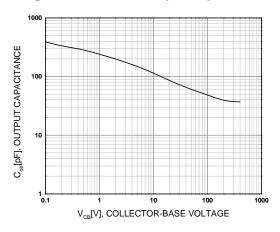


Figure 4. Turn On Time

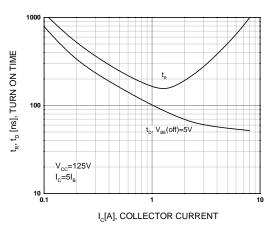


Figure 5. Turn Off Time

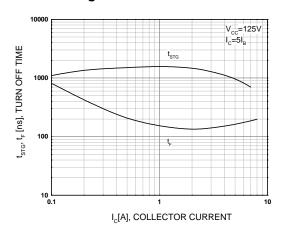
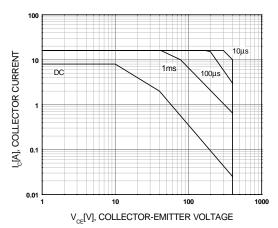


Figure 6. Forward Biased Safe Operating Area



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Typical Performance Characteristics (Continued)

Figure 7. Reverse Biased Safe Operating Area

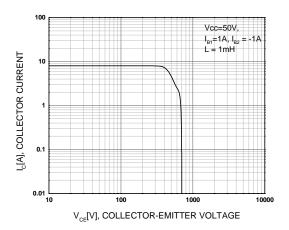
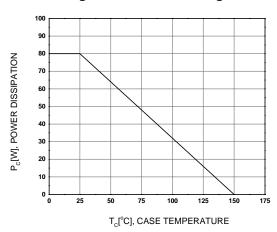
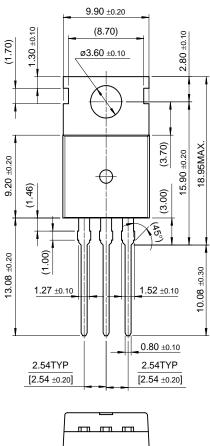


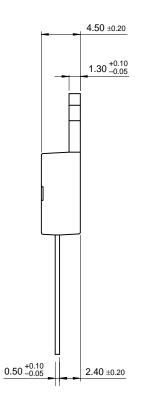
Figure 8. Power Derating



Mechanical Dimensions

TO-220





10.00 ±0.20

Dimensions in Millimeters

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